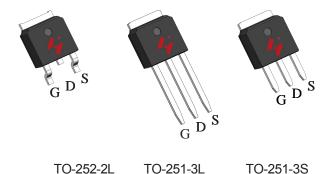


N-Channel Enhancement Mode MOSFET

Features

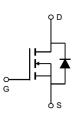
- 30V/42A $R_{DS(ON)} = 10 \text{ m}\Omega(\text{typ.})$ @Ves =- 10V $R_{DS(ON)} = 14 \text{ m}\Omega(\text{typ.})$ @Ves = -4.5V
- 100% Avalanche Tested
- Reliable and Rugged
- Halogen Free and Green Devices Available (RoHS Compliant)

Pin Description



Applications

- Switching Application
- Power Management for DC/DC



N-Channel MOSFET

U: TO-251-3L

Ordering and Marking Information



Package Code

D : TO-252-2L

V: TO-251-3S

Date Code Assembly Material YYXXX WW G: Halogen Free

Note: HUAYI lead-free products contain molding compounds/die attach materials and 100% matte tin plate Termi-Nation finish; which are fully compliant with RoHS. HUAYI lead-free products meet or exceed the lead-free require-ments of IPC/JEDEC J-STD-020 for MSL classification at lead-free peak reflow temperature. HUAYI defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

HUAYI reserves the right to make changes, corrections, enhancements, modifications, and improvements to this pr-oduct and/or to this document at any time without notice.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit	
Common F	Ratings (T _C =25°C Unless Otherwise Noted)		•	
V _{DSS}	Drain-Source Voltage		30	V
V _{GSS}	Gate-Source Voltage		±20	
TJ	Maximum Junction Temperature		150	°C
T _{STG}	Storage Temperature Range		-55 to 150	°C
Is	Diode Continuous Forward Current	T _C =25°C	42	А
Mounted o	on Large Heat Sink			•
I _{DM}	Pulsed Drain Current *	T _C =25°C	140**	А
			42	
l I _D	Continuous Drain Current	T _C =100°C	30	_ A
Б	Mayira ya Dayyar Dissination	T _c =25°C 3	30	١٨/
P _D	Maximum Power Dissipation T _C =100°C		12	w
$R_{\theta JC}$	Thermal Resistance-Junction to Case		4.2	°C/W
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient		110	°C/W
E _{AS}	Drain-Source Avalanche Energy L=0.5mH		70***	mJ

Note : * Repetitive rating ; pulse width limited by junction temperature
** Drain current is limited by junction temperature

Electrical Characteristics (T_c = 25°C Unless Otherwise Noted)

Cumbal	Parameter	Toot Conditions		HY1403		Unit
Symbol	Parameter Test Conditions		Min.	Тур.	Max.	Unit
Static Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250μA	30	-	-	V
	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V	-	-	1	
I _{DSS}	Zero Gate Voltage Drain Current	T _J =125°C	_	-	50	μΑ
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS} , I_{DS} =250μA	1.0	1.6	3.0	V
I _{GSS}	Gate Leakage Current	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
D *	Drain Course On state Decistores	V _{GS} =10V, I _{DS} =21A	-	10	11	mΩ
R _{DS(ON)} *	Drain-Source On-state Resistance	Orain-Source On-state Resistance V_{GS} =4.5V, I_{DS} =21A		14	17	mΩ
Diode Ch	Diode Characteristics					
V _{SD} *	Diode Forward Voltage	I _{SD} =21A, V _{GS} =0V	-	0.8	1.1	V
t _{rr}	Reverse Recovery Time	L =21A dL /dt=100A/	-	21	-	ns
Q _{rr}	Reverse Recovery Charge	I _{DS} =21A, dl _{SD} /dt=100A/μs	-	13	-	nC

^{***} VD=24V



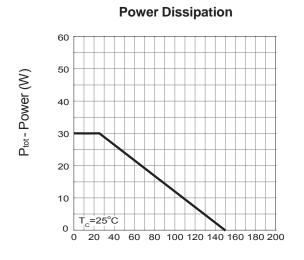
Electrical Characteristics (Cont.) $(T_c = 25^{\circ}C \text{ Unless Otherwise Noted})$

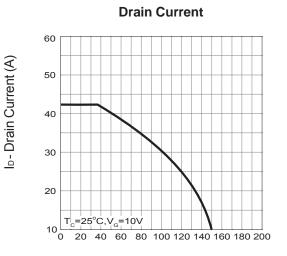
Symbol	Parameter	Test Conditions		HY1403		Unit
	Farameter	rest Conditions	Min.	Тур.	Max.	Ollit
Dynamic	Characteristics					
R_G	Gate Resistance	V _{GS} =0V,V _{DS} =0V,F=1MHz	-	2.9	-	Ω
C _{iss}	Input Capacitance	V _{GS} =0V,	-	1012	-	
C _{oss}	Output Capacitance	V _{DS} =15V,	-	251	-	pF
C _{rss}	Reverse Transfer Capacitance	Frequency=1.0MHz	-	119	1	
$t_{d(ON)}$	Turn-on Delay Time	V_{DD} =15 V, R_{G} = 3 Ω , I_{DS} =21A, V_{GS} =10 V,	-	15	28	
Tr	Turn-on Rise Time		-	13	24	ns
$t_{\text{d(OFF)}}$	Turn-off Delay Time		-	20	35	113
T_f	Turn-off Fall Time		-	10	19	
Gate Cha	Gate Charge Characteristics					
Q_g	Total Gate Charge	V _{DS} =24V, V _{GS} =10 V, I _{DS} =21A	-	29	-	
Q _{gs}	Gate-Source Charge		-	4.6	-	nC
Q_{gd}	Gate-Drain Charge		-	4.3	-	

Note * : Pulse test ; pulse width \leq 300 μ s, duty cycle \leq 2%.



Typical Operating Characteristics

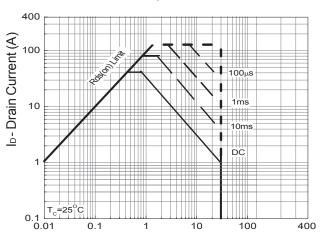




T_c- Case Temperature (°C)

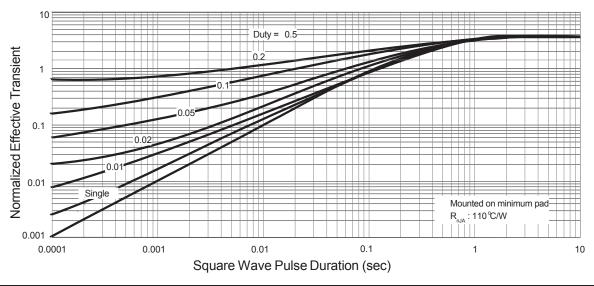
T_c-Case Temperature (°C)

Safe Operation Area



V_{DS} - Drain - Source Voltage (V)

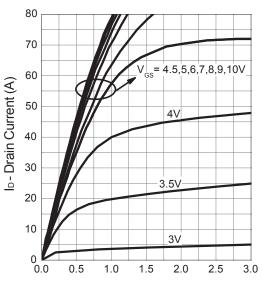
Thermal Transient Impedance





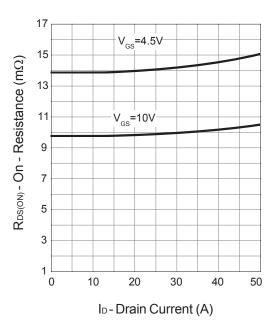
Typical Operating Characteristics (Cont.)

Output Characteristics

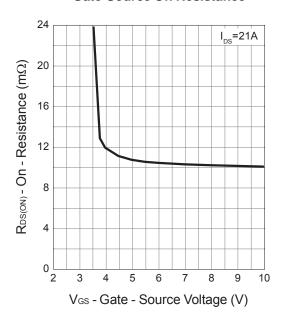


V_{DS} - Drain - Source Voltage (V)

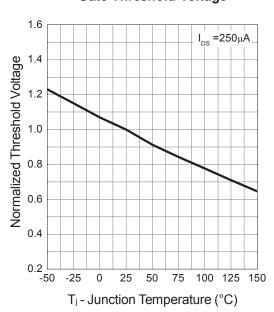
Drain-Source On Resistance



Gate-Source On Resistance



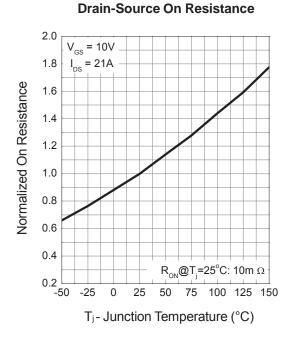
Gate Threshold Voltage



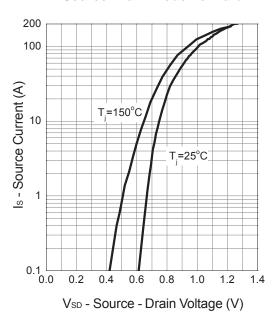


Typical Operating Characteristics (Cont.)

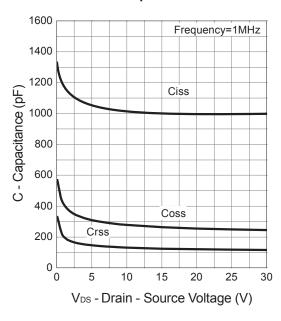




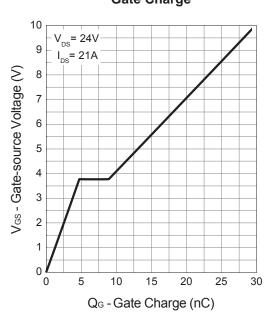
Source-Drain Diode Forward



Capacitance

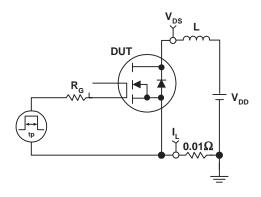


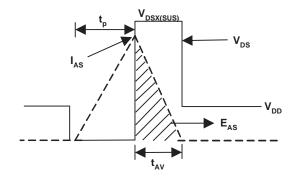
Gate Charge



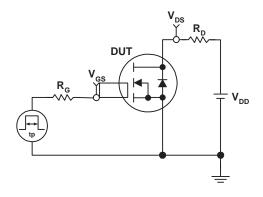


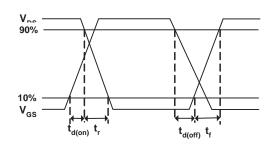
Avalanche Test Circuit





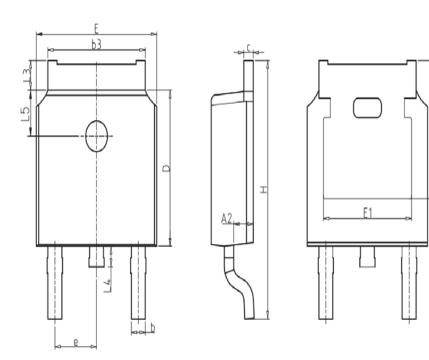
Switching Time Test Circuit





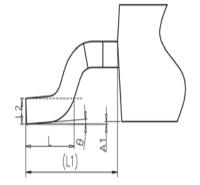


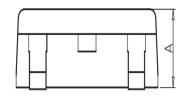
Package Information TO-252-2L



COMMON DIMENSIONS

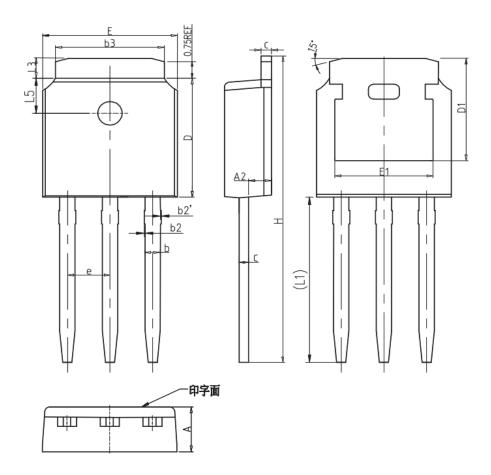
SYMBOL		mm	
STINIDOL	MIN	NOM	MAX
Α	2.20	2.30	2.40
A1	0.00	-	0.20
A2	0.97	1.07	1.17
b	0.68	0.78	0.90
b3	5.20	5.33	5.50
С	0.43	0.53	0.63
D	5.98	6.10	6.22
D1	5.30REF		
Е	6.40	6.60	6.80
E1	4.63	-	-
е		2.286BS	C
Н	9.40	10.10	10.50
L	1.38	1.50	1.75
L1		2.90REF	
L2	0.51BSC		
L3	0.88	-	1.28
L4	-	-	1.00
L5	1.65	1.80	1.95
θ	0°	-	8°







TO-251-3L



COMMON DIMENSIONS

SYMBOL		mm	
OTIVIDOL	MIN	NOM	MAX
Α	2.20	2.30	2.40
A2	0.97	1.07	1.17
b	0.68	0.78	0.90
b2	0.00	0.04	0.10
b2'	0.00	0.04	0.10
b3	5.20	5.33	5.50
С	0.43	0.53	0.63
D	5.98	6.10	6.22
D1		5.30REF	
E	6.40	6.60	6.80
E1	4.63	-	-
e		2.286BSC	
Н	16.22	16.52	16.82
L1	9.15	9.40	9.65
L3	0.88	1.02	1.28
L5	1.65	1.80	1.95

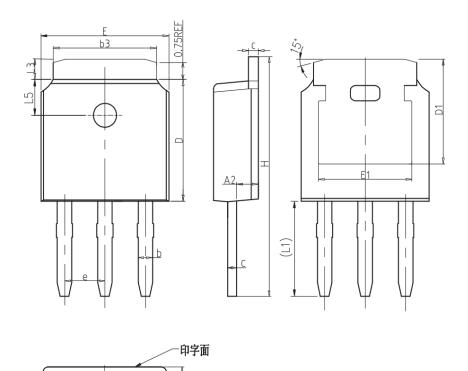
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TO-251-3L



COMMON DIMENSIONS

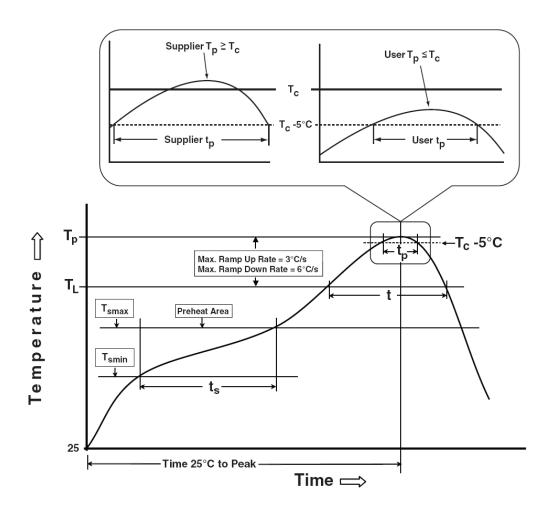
SYMBOL	mm			
STIVIBOL	MIN	NOM	MAX	
А	2.20	2.30	2.40	
A2	0.97	1.07	1.17	
b	0.68	0.78	0.90	
b3	5.20	5.33	5.50	
С	0.43	0.53	0.63	
D	5.98	6.10	6.22	
D1	5.30REF			
E	6.40	6.60	6.80	
E1	4.63	-	-	
е		2.286BSC		
Н	10.00	11.22	11.44	
L1	3.90	4.10	4.30	
L3	0.88	1.02	1.28	
L5	1.65	1.80	1.95	



Device Per Unit

Package Type	Unit	Quantity
TO-252-2L	Tube	75
TO-252-2L	Reel	2500
TO-251-3L	Tube	75
TO-251-3S	Tube	75

Classification Profile





Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly	
Preheat & Soak Temperature min (T _{smin}) Temperature max (T _{smax}) Time (T _{smin} to T _{smax}) (t _s)	100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-120 seconds	
Average ramp-up rate (T _{smax} to T _P)	3 °C/second max.	3°C/second max.	
Liquidous temperature (T _L) Time at liquidous (t _L)	183 °C 60-150 seconds	217 °C 60-150 seconds	
Peak package body Temperature $(T_p)^*$	See Classification Temp in table 1	See Classification Temp in table 2	
Time $(t_P)^{**}$ within 5°C of the specified classification temperature (T_c)	20** seconds	30** seconds	
Average ramp-down rate (T _p to T _{smax})	6 °C/second max.	6 °C/second max.	
Time 25°C to peak temperature	6 minutes max.	8 minutes max.	
* Tolerance for peak profile Temperature (T_p) is defined as a supplier minimum and a user maximum. ** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.			

Table 1. SnPb Eutectic Process – Classification Temperatures (Tc)

Package Thickness	Volume mm ³ <350	Volume mm³ ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2. Pb-free Process – Classification Temperatures (Tc)

Package	Volume mm ³	Volume mm ³	Volume mm ³
Thickness	<350	350-2000	>2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

Reliability Test Program

Test item	Method	Description
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C
HOLT	JESD-22, A108	168 Hrs /500 Hrs /1000 Hrs, Bias @ 150°C
PCT	JESD-22, A102	96 Hrs, 100%RH, 2atm, 121°C
TCT	JESD-22, A104	500 Cycles, -55°C~150°C

Customer Service

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^{**} Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.